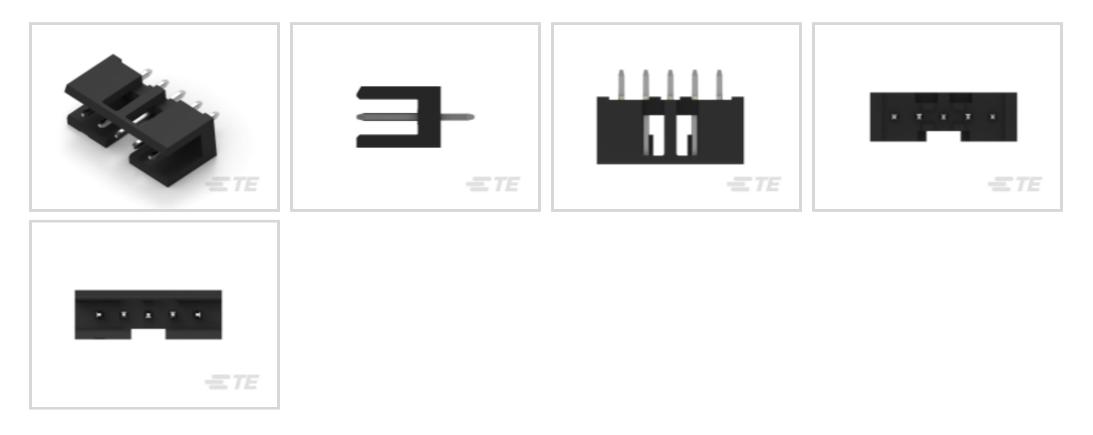
#### AMPMODU | AMPMODU 2 mm

TE Internal #: 1-2823382-2 PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2 mm [. 079 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU 2 mm

#### View on TE.com >

#### Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: **Board-to-Board** Number of Positions: **12** 

Centerline (Pitch): 2 mm [.079 in ]

Sealable: No

PCB Mount Orientation: Vertical

### Features



#### Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Header Type	Partially Shrouded
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	No
Number of Positions	12
PCB Mount Orientation	Vertical
Number of Rows	1
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	650 VAC
Operating Voltage	250 VAC
Body Features	

PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU 2 mm



Connector Profile	Standard
Primary Product Color	Black
Contact Features	
Contact Mating Area Length	4 mm[.157 in]
Mating Square Post Dimension	.5 mm[.02 in]
PCB Contact Termination Area Plating Material Thickness	3 – 5 μm[100 – 200 μin]
Contact Layout	Inline
Contact Type	Pin
Contact Underplating Material Thickness	1.27 μm[50 μin]
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Current Rating (Max)	2 A



#### **Termination Features**

Square Termination Post & Tail Dimension	.5 mm[.02 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Retention	Without
Connector Mounting Type	Panel Mount
Housing Features	
Housing Material	LCP (High Temp Thermoplastic)
Centerline (Pitch)	2 mm[.079 in]
Dimensions	
Connector Length	26 mm[1.024 in]
Usage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-40 – 105 °C[-40 – 221 °F]
Operation/Application	

**C** For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU 2 mm



Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Type	Tube
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2023 (233) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

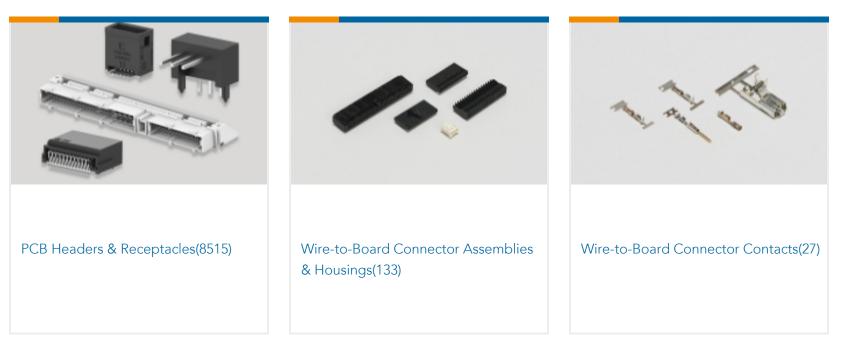
## **Compatible Parts**

PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU 2 mm





## Also in the Series | AMPMODU 2 mm



## Documents

### CAD Files 3D PDF

3D

. . . . . . .

**Customer View Model** 

ENG\_CVM\_CVM\_1-2823382-2\_1.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_1-2823382-2\_1.3d\_igs.zip

English

Customer View Model ENG\_CVM\_CVM\_1-2823382-2\_1.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages AMPMODU 2mm interconnection system QRG English Flyer - AMPMODU 2mm Shrouded Header English Product Specifications Application Specification

English

Agency Approvals

**&** For support call+1 800 522 6752

PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2 mm [.079 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, AMPMODU 2 mm



**VDE** Certificate

English